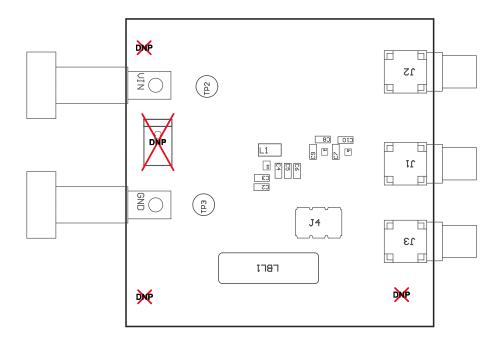
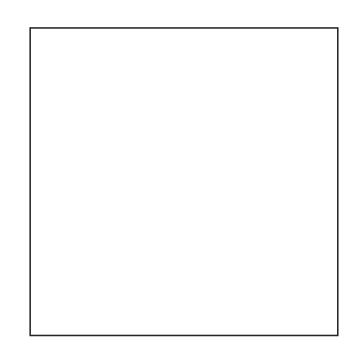
- This Assembly Note is for PCB labels only
- ■These assemblies are ESD sensitive, ESD precautions shall be observed.
- ■These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REU: A	SUN REU	: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 11/24/	2015 10:20:00	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/24/	2015 10:20:00	AM	TEXAS INSTRUMENTS

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